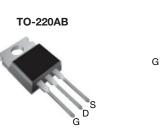
Vishay Siliconix

Power MOSFET

| PRODUCT SUMMARY | | | | |
|--------------------------|-----------------------------|--|--|--|
| V _{DS} (V) | 600 | | | |
| R _{DS(on)} (Ω) | V _{GS} = 10 V 0.75 | | | |
| Q _g max. (nC) | 49 | | | |
| Q _{gs} (nC) | 13 | | | |
| Q _{gd} (nC) | 20 | | | |
| Configuration | Single | | | |

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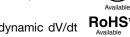




N-Channel MOSFET

FEATURES

 \bullet Low gate charge Q_{g} results in simple drive requirement



- Improved gate, avalanche and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- High speed power switching

APPLICABLE OFF LINE SMPS TOPOLOGIES

- Active clamped forward
- Main switch

| ORDERING INFORMATION | | | |
|----------------------|---------------|--|--|
| Package | TO-220AB | | |
| Lead (Pb)-free | IRFB9N60APbF | | |
| Lead (Fb)-free | SiHFB9N60A-E3 | | |
| SnPb | IRFB9N60A | | |
| SNPD | SiHFB9N60A | | |

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | |
|--|-------------------------|--|-----------------------------------|-------------|----------|
| PARAMETER | | | SYMBOL | LIMIT | UNIT |
| Drain-Source Voltage | | | V _{DS} | 600 | V |
| Gate-Source Voltage | | | V _{GS} | ± 30 | v |
| $T_{\rm C} = 25 ^{\circ}{\rm C}$ | | | | 9.2 | |
| Continuous Drain Current | V _{GS} at 10 V | $T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$ | I _D | 5.8 | А |
| Pulsed Drain Current ^a | | | I _{DM} | 37 | |
| Linear Derating Factor | | | | 1.3 | W/°C |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 290 | mJ |
| Repetitive Avalanche Current ^a | | | I _{AR} | 9.2 | A |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 17 | mJ |
| Maximum Power Dissipation $T_{C} = 25 \text{ °C}$ | | | PD | 170 | W |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 5.0 | V/ns |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | -55 to +150 | °C |
| Soldering Recommendations (Peak temperature) ^d for 10 s | | | | 300 | |
| Mounting Torque | 6.20 or 1 | 6.00 or M2 corous | | 10 | lbf ∙ in |
| Mounting Torque | 6-32 or M3 screw | | | 1.1 | N · m |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting T_J = 25 °C, L = 6.8 mH, R_g = 25 Ω , I_{AS} = 9.2 A (see fig. 12).

c. $I_{SD} \le 9.2$ A, dI/dt ≤ 50 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

S16-0763-Rev. D, 02-May-16



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| THERMAL RESISTANCE RATINGS | | | | |
|-------------------------------------|-------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.50 | - | °C/W |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 0.75 | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|--|---|------------|-----------|--------|-------|
| Static | | - | | | • | • | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} | = 0 V, I _D = 250 μA | 600 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Referen | ce to 25 °C, I _D = 1 mA | - | 660 | - | mV/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} | = V _{GS} , I _D = 250 μA | 2.0 | - | 4.0 | V |
| Gate-Source Leakage | I _{GSS} | | $V_{GS} = \pm 30 \text{ V}$ | - | - | ± 100 | nA |
| Zero Gate Voltage Drain Current | Inna | V _{DS} : | = 600 V, V _{GS} = 0 V | - | - | 25 | μA |
| Zero Gate Voltage Drain Gurrent | I _{DSS} | V _{DS} = 480 V | /, V _{GS} = 0 V, T _J = 125 °C | - | - | 250 | |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 5.5 A ^b | - | - | 0.75 | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} | = 50 V, I _D = 5.5 A | 5.5 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | | $V_{GS} = 0 V,$ | - | 1400 | - | |
| Output Capacitance | C _{oss} | _ | V _{DS} = 25 V, | - | 180 | - | |
| Reverse Transfer Capacitance | C _{rss} | f = 1 | .0 MHz, see fig. 5 | - | 7.1 | - | pF |
| Output Canaditanaa | C _{oss} | | V _{DS} = 1.0 V, f = 1.0 MHz | - | 1957 | - | |
| Output Capacitance | | $V_{GS} = 0 V$ | V _{DS} = 480 V, f = 1.0 MHz | - | 49 | - | |
| Effective Output Capacitance | Coss eff. | | V _{DS} = 0 V to 480 V | - | 96 | - | |
| Total Gate Charge | Qg | | | | - | 49 | nC |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 10 \text{ V}$ $I_D = 9.2 \text{ A}, V_{DS} = 400 \text{ V}$ | | - | - | 13 | |
| Gate-Drain Charge | Q _{gd} | | see fig. 6 and 13 ^b | | - | 20 | |
| Turn-On Delay Time | t _{d(on)} | | | - | 13 | - | |
| Rise Time | t _r | V _{DD} = 300 V, I _D = 9.2 A | | - | 25 | - | |
| Turn-Off Delay Time | t _{d(off)} | R_{g} = 9.1 Ω, R_{D} = 35.5 Ω, see fig. 10 ^b | | - | 30 | - | ns |
| Fall Time | t _f | $m_g = 3.1 \text{ sz}, m_D = 33.3 \text{ sz}, \text{ see fig. 10}^2$ | | - | 22 | - | 1 |
| Gate Input Resistance | R _g | f = 1 MHz, open drain | | 0.5 | - | 3.2 | Ω |
| Drain-Source Body Diode Characteristic | S | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 9.2 | A |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 37 | |
| Body Diode Voltage | V_{SD} | T _J = 25 °C, I _S = 9.2 A, V _{GS} = 0 V ^b | | - | - | 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | $T_J = 25 \text{ °C}, I_F = 9.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^{\text{b}}$ | | - | 530 | 800 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 3.0 | 4.4 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic tu | rn-on time is negligible (turn- | -on is dor | ninated b | vleand | |

Notes

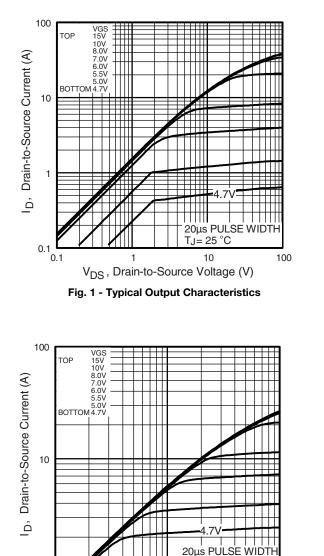
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} effective is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Tj= 150 °C

100

10

V_{DS}, Drain-to-Source Voltage (V)

Fig. 2 - Typical Output Characteristics

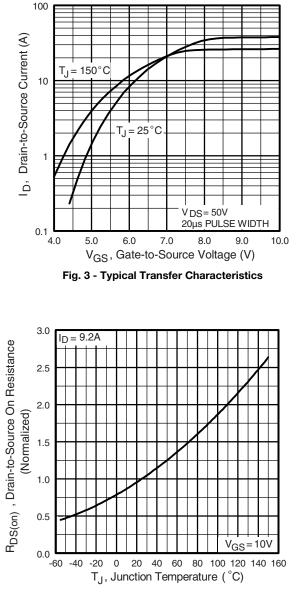


Fig. 4 - Normalized On-Resistance vs. Temperature

1



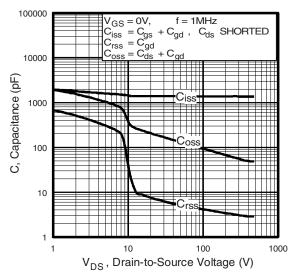


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

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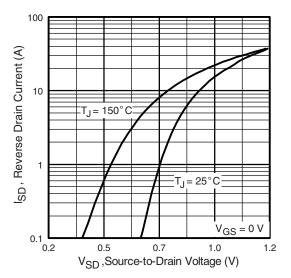


Fig. 7 - Typical Source-Drain Diode Forward Voltage

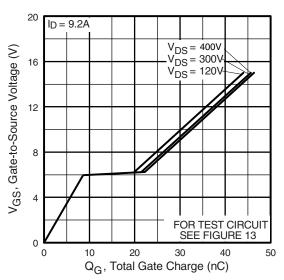


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

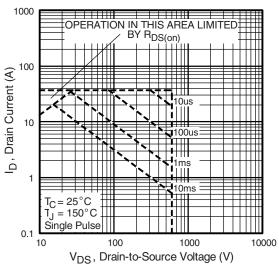


Fig. 8 - Maximum Safe Operating Area

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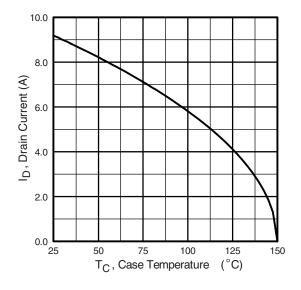


Fig. 9 - Maximum Drain Current vs. Case Temperature

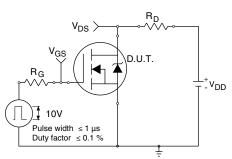


Fig. 10a - Switching Time Test Circuit

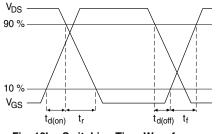


Fig. 10b - Switching Time Waveforms

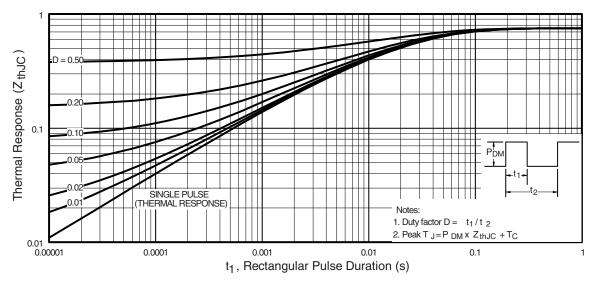
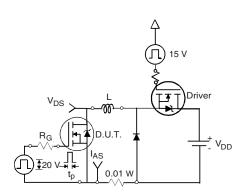


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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Fig. 12a - Unclamped Inductive Test Circuit

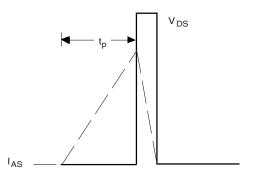


Fig. 12b - Unclamped Inductive Waveforms

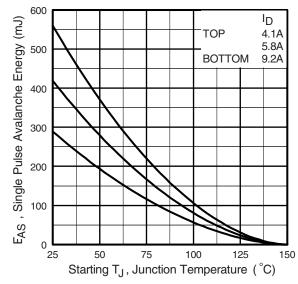
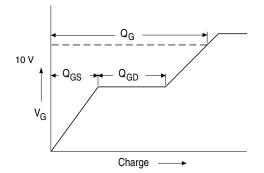
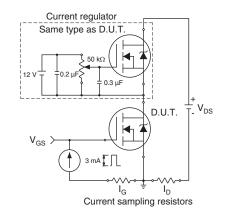


Fig. 12c - Maximum Avalanche Energy vs. Drain Current









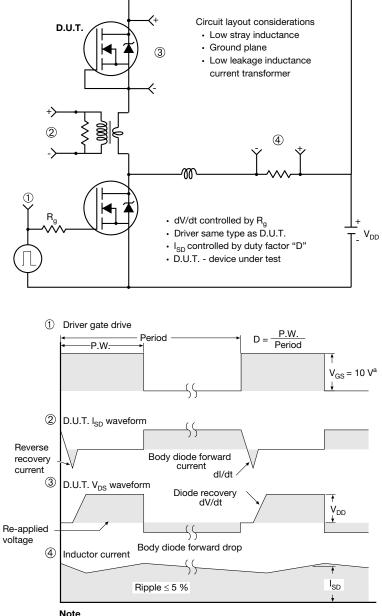
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



| DIM. | MILLIN | IETERS | INCHES | |
|--|--------|--------|--------|-------|
| DIN. | MIN. | MAX. | MIN. | MAX. |
| А | 4.24 | 4.65 | 0.167 | 0.183 |
| b | 0.69 | 1.02 | 0.027 | 0.040 |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 |
| С | 0.36 | 0.61 | 0.014 | 0.024 |
| D | 14.33 | 15.85 | 0.564 | 0.624 |
| E | 9.96 | 10.52 | 0.392 | 0.414 |
| е | 2.41 | 2.67 | 0.095 | 0.105 |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 |
| F | 1.14 | 1.40 | 0.045 | 0.055 |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 |
| L | 13.36 | 14.40 | 0.526 | 0.567 |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 |
| ØР | 3.53 | 3.94 | 0.139 | 0.155 |
| Q | 2.54 | 3.00 | 0.100 | 0.118 |
| ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031 | | | | |

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

| Package Picture | | | | |
|-----------------|--|---------------------|-----|--|
| ASE | | Xi | 'an | |
| | | IRF 9510 744K AB | | |

Revison: 14-Dec-15

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